STABILITY OF ASYMMETRIC GRAIN BOUNDARIES IN GRAPHENE

J. P. Mendez\textsuperscript{1}, F. Arca\textsuperscript{2} and M. P. Ariza\textsuperscript{2}

\textsuperscript{1}Division of Engineering and Applied Science, California Institute of Technology, Pasadena, CA 91125, USA
e-mail: jmendezyg@caltech.edu

\textsuperscript{2}Escuela Técnica Superior de Ingeniería, Universidad de Sevilla, Camino de los descubrimientos, s.n., 41092 Sevilla, Spain
e-mail: \{farca,mpariza\}@us.es

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Abstract. In the field of electronics, due to its excellent mechanical and electrical properties, graphene has become the most promising material for the production of next generation thin and flexible graphene-based electronic components. In this work, we present an assessment of the thermal stability and dynamics of asymmetric grain boundaries in graphene for different misorientation angles at finite temperature and up to extremely high temperatures. In particular, we have focused on configurations with misorientation angle of 16.1°, 30° and 38.2°. In contrast to pristine defect-free graphene, which has no band-gap and therefore is of limited use for semiconductor-based electronics, it has been shown theoretically that line defects in graphene might insert transport gaps, opening up the possibility of device applications based on the structural engineering of graphene boundaries.
1 INTRODUCTION

Graphene, owing to its extraordinary properties [1, 2], can be used to a wide range of applications: aerospace, where carbon fibers that are used to reinforce composite materials can be replaced by graphene and, as a result, the weight of aircraft might be reduced considerably as well as the electrical conductivity will be enhanced for lightning strikes during flights; military industry, where graphene can be used as substitution of Kevlar in bulletproof vest [3]; bioengineering, where graphene can be used to fabricate bioelectric sensors [4, 5]; or in the field of electronics, where graphene has become the most promising material for the production of thin and flexible electronic components of next generation [6, 7].

However, the use of graphene in semiconductor-based devices is limited due to the fact that free-defect graphene lacks band gap, which is crucial for the correct operation of these devices. In order to achieve an electrical function and due to the presence of band gap, semiconductors exhibit the ability to switch currents on and off as desired. Many attempts have been carried out in order to introduce this desired band gap, e.g., by doping graphene with boron and nitrogen [8] or by engineering defects such as vacancies, Stone-Wales and dislocations [9], and grain boundaries (GBs) [10]. It has been proved, either experimentally or theoretically, that the presence of point defects modify locally the electronic properties [11, 12], but do not endow the layer with a band gap wide enough for such applications. Nevertheless, it has been seen that the presence of grain boundaries alters the electronic properties, and more specifically, some configurations might introduce a transport gap across them that would block the charge carriers in a range of energy. As a consequence, due to the current technology advances, the design of suited GB configurations opens a new potential via to tailor a tunable transport gap in graphene and, therefore, to use graphene as the base material for the manufacturing of semiconductor-based devices, e.g., nanotransistors [13].

With the main target of tuning the carrier transport in graphene, we will carry out an appraisal of the stability and dynamics of asymmetric GBs that could appear in graphene lattice. Additionally, owing to the fact that temperature is always present during the performance of electronic devices, the thermal stability of these GBs will play an important role when designing electronic nanocomponents. Therefore, in this work we will also conduct an analysis of the thermal stability of the predicted GB configurations during a long period of time and up to extremely high temperatures. To this end, we will proceed by applying the same methodology followed by the authors for the thermal characterization of dislocations [14] and symmetric grain boundaries [10] in graphene.

2 ASYMMETRIC GRAIN BOUNDARIES IN GRAPHENE

The simulation model used for studying the stability of GBs is depicted in Fig. 1. This model consists of two grains (A and B) with different crystallographic orientations ($\theta_1$ and $\theta_2$) and periodic boundary conditions applied in both directions (X and Y axis). The boundary effects are an obstacle that one has to tackle in this kind of simulations and usually emerge when the cell size is small. Owing to avoid these effects, the simulation cell has to be as large as possible, therefore, the cell size is of the order of thousands of atoms ($\sim 10^3$) in this study.

The misorientation angle, $\theta$, is defined as $\theta = \theta_1 + \theta_2$, where $\theta_1$ and $\theta_2$ are the orientation angles of grain A and B with respect to the horizontal axis $X$, respectively. Another interesting parameter to be considered here is the inclination angle of the boundary line, $\phi$, that is defined as $\phi = |\theta_1 - \theta_2|$. On the other hand, inasmuch as graphene crystallographic structure possesses two high symmetry directions, i.e., the zig-zag and armchair directions (see Fig. 2), we fix the
zig-zag direction when the orientation angle of grain $\theta_i$ ($i = 1, 2$) is equal to $0^\circ$ and therefore the armchair direction is reached when the orientation angle $\theta_i$ ($i = 1, 2$) is equal to $30^\circ$.

Regarding grain boundary configurations, we can distinguish two types: symmetric and asymmetric. When $\theta_1 = \theta_2$, GBs are symmetric and the inclination angle is $\phi = 0$, whereas GBs are asymmetric when $\theta_1 \neq \theta_2$ and, therefore, $\phi = \theta_1 - \theta_2 \neq 0$. For the purpose of evaluating all possible GB configurations, it is only necessary to cover the range of $\theta_1$ and $\theta_2$ that varies between $0^\circ$ and $30^\circ$. Therefore, symmetric configurations posses one degree of freedom $\theta$ ($\theta_1$ or $\theta_2$) and have to be defined by the misorientation angle, and asymmetric GBs have two degrees of freedom ($\theta_1$ and $\theta_2$) and can be denoted by $(\theta_1 | \theta_2)$. Additionally, as GBs are traditionally modelled as a periodic arrangement of dislocations [15], they can be described by $(n_A, m_A) | (n_B, m_B)$, where $(n_i, m_i) i = A, B$ represents the periodic translations vector of grains A and B along GB and referred to their respective basis set ($a_1, a_2$). In particular, $n_A = n_B$ and $m_A = m_B$ for symmetric configurations. Finally, the misorientation angle can be calculated in a straightforward manner through

$$\theta = \arctan((n_A - m_A)/\sqrt{3}/(m_A + n_A)) + \arctan((m_B - n_B)/\sqrt{3}/(m_B + n_B))$$

### 2.1 Structures and energies

With the main purpose of finding misorientation angles corresponding to stable configurations at 0K, we have simulated an endless number of configurations with different angles by means of molecular dynamics, covering a wide range of possibilities. Owing to the fact that $\theta_1 \neq \theta_2$ for asymmetric GBs, the characterization of these GBs is more challenging than for symmetric configurations [10]. To accomplish this, we have resorted the widely used molecular
Table 1: Energies for different asymmetric grain boundaries in graphene.

<table>
<thead>
<tr>
<th>Misorientation angle(θ)</th>
<th>GB configuration</th>
<th>Energy (eV/Å)</th>
</tr>
</thead>
<tbody>
<tr>
<td>16.1° (16.1°</td>
<td>0°)</td>
<td>(3,1)</td>
</tr>
<tr>
<td>16.1° (0°</td>
<td>16.1°)</td>
<td>(2,2)</td>
</tr>
<tr>
<td>30° (30°</td>
<td>0°)</td>
<td>(5,0)</td>
</tr>
<tr>
<td>30° (0°</td>
<td>30°)</td>
<td>(3,3)</td>
</tr>
<tr>
<td>38.2° (8.21°</td>
<td>30°)</td>
<td>(5,3)</td>
</tr>
</tbody>
</table>

3 Thermal stability

Afterwards, we have analysed the mechanical behaviour and thermal stability at finite temperature of these GB structures up to extremely high temperatures. For this purpose, we have relaxed each configuration during a long period of time, up to 10.000ps, and at fixed constant
As main outcomes of our simulations, we state the following conclusions:

1. Asymmetric configurations remain stable up to very high temperature, around 3000K. As we can observe from Fig. 5a for a misorientation angle of 38.2°, dislocations type (1,0) and (1,0)+(0,1) which form the grain boundary are unaffected by the temperature.

2. At temperature exceeding 3000K, it is observed transformations, motions and slip-up of dislocations. For instance, as we can see in the rectangles marked in Figs. 5b and c, a (1,0)+(0,1) dislocation segregate into two dislocations, and the resulting dislocations move and one of them joins to a (1,0) dislocation to form new dislocation. Additionally, we show in Fig. 6 as an example the glide motion of a (1,0) dislocation.
Figure 5: Observed asymmetric grain boundary structures for a misorientation angle of 38.2° at different temperatures (a) $T \leq 3000$K, (b) $T=3500$K, and (c) $T=4000$K.
3. Above 4000K, asymmetric GBs collapse. Similar to symmetric configurations, the presence of GBs accelerates the melting process and decreases the melting temperature. Therefore, these defects act as a trigger for melting.

4 CONCLUSIONS

In the present work, we have analysed the dynamics and the thermal stability of asymmetric GBs for different misorientation angles. First, we have obtained atomic configurations corresponding to stable GBs using the LAMMPS code and the AIREBO and ReaxFF potentials. In particular, we have obtained that the misorientation angles $16.1^\circ$, $30^\circ$ and $38.2^\circ$ are stable in graphene. Afterwards, we have relaxed these configurations at finite temperature up to very high temperature, close to the melting temperature for graphene. As results, we have reported a high stability against annihilation up to extreme temperatures, about 3000K, high mobility and transformation of dislocations at higher temperatures and the melting of grain boundaries at temperatures above 4000K.

REFERENCES


